

N-Channel 100-V (D-S) MOSFET

Description

The device is using trench DMOS technology. This advanced technology has been especially tailored to minimize $R_{DS(ON)}$, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

The device meets the RoHS and Green Product requirement, 100% EAS guaranteed with full function reliability approved.

Features

- R_{DS(ON)} =6.5mΩ@ V_{GS} =10V
- Fast switching
- Improve dv/dt Capability
- 100% EAS Guaranteed
- Green Device Available

Typical Applications

- Networking
- Load Switch
- Synchronous Rectifier
- Quick Charger

Package type: PDFN 5X6

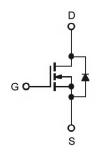
Packing & Order Information

3,000/Reel

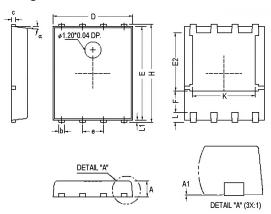


RoHS Compliant

Graphic Symbol

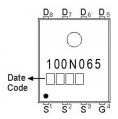


Package Dimension



REF.	Millimeter		REF.	Millimeter			
	Min.	Nom.	Max.	REF.	Min.	Nom.	Max.
Α	0.85	1.00	1.15	E	5.70	-	5.90
A1	0.00	-	0.10	е	-	1.27	-
b	0.30	-	0.51	Н	5.90	-	6.20
С	0.20	-	0.30	L	-	0.60	-
D	4.80	-	5.00	L1	0.06	-	0.20
F	1.10 Ref.			α	0°	-	12°
E2	3.50 Ref.			K	3.70	3.90	4.10

Marking





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MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute N	Maximum Ratings		
Symbol	Parameter	Value	Units
V _{DS}	Drain-Source Voltage	100	V
V _G S	Gate-Source Voltage	+20/-12	V
1	Continuous Drain Current¹ (T _C =25°C)	70	А
I _D	Continuous Drain Current ¹ (T _C =100°C)	44	Α
I _{DM}	Pulsed Drain Current ^{1,2}	280	Α
las	Single Pulse Avalanche Current, L =0.1mH³	55	А
Eas	Single Pulse Avalanche Energy, L =0.1mH³	151	mJ
D	Power Dissipation ⁴ (T _C =25°C)	62.5	W
P _D	Power Dissipation ⁴ (T _A =25°C)	2	W
TJ/T _{STG}	Operating Junction and Storage Temperature	-50 to +150	°C

Thermal Resistance Ratings						
Symbol	Parameter	Maximum	Units			
$R_{\theta JA}$	Maximum Junction-to-Ambient ¹	60	°C/W			
Rejc	Maximum Junction-to-Case ¹	2	°C/W			

Electrical Characteristics (T _J =25°C unless otherwise specified)							
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
$V_{\text{GS (th)}}$	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	2.0	3.0	4.0	V	
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	100	-	-	V	
g fs	Forward Transconductance	V _{DS} =10V, I _D =5A	-	8	-	S	
Igss	Gate-Source Leakage Current	V _{DS} =0V, V _{GS} =20V	-	-	100	nA	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =100V, V _{GS} =0V, T _J =25°C V _{DS} =80V, V _{GS} =0V, T _J =85°C	-	-	1 10	μA	
R _{DS (on)}	Static Drain-Source On-Resistance ²	V _{GS} =10V, I _D =30A	-	5.4	6.5	mΩ	
EAS	Single Pulse Avalanche Energy ⁵	V _{DD} =25V, L =0.1mH, I _{AS} =40A	80		-	mJ	
VsD	Diode Forward Voltage ²	I _S =30A, V _{GS} =0V, T _J =25°C	-	-	1.2	V	
ls	Continuous Source Current ^{1,6}	V V 0V 5 0	-	-	70		
Ism	Pulsed Source Current ^{2,6}	V _G =V _D =0V, Force Current	-	-	140	Α	

Notes

- 1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2. The data tested by pulsed, pulse width \leq 300us, duty cycle \leq 2%.
- 3. The EAS data shows maximum rating. The test condition is V_{DD} =25V, V_{GS} =10V, L=0.1mH, I_{AS} =55A.
- 5. The Min. value is 100% EAS tested guarantee.
- The data is theoretically the same as I_D and I_{DM}, in real applications, should be limited by total power dissipation.



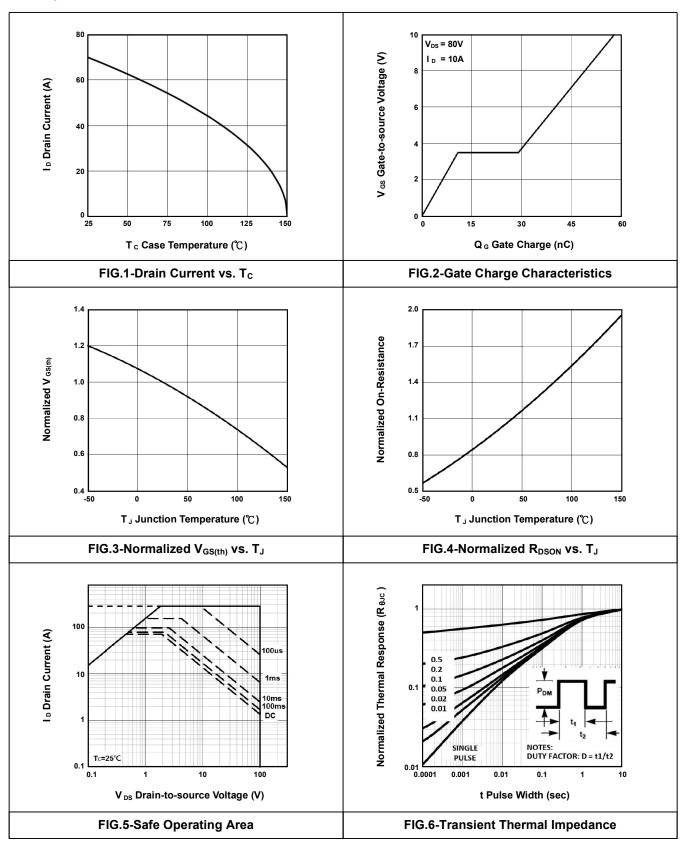
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Dynamic						
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Qg	Total Gate Charge ²	V _{DS} =80V		57.9		
Qgs	Gate-Source Charge	I _D =10A		10.8		nC
Qgd	Gate-Drain Charge	V _{GS} =10V		18.2		
td(on)	Turn-On Delay Time ²	V _{DS} =50V		24		
tr	Rise Time	I _D =1A		19.8		
td(off)	Turn-Off Delay Time	V _{GS} =10V		46		ns
tf	Fall Time	R _G =6Ω		26		
Ciss	Input Capacitance	V _{DS} =50V		3590		
Coss	Output Capacitance	V _{GS} =0V		590		pF
C _{RSS}	Reverse Transfer Capacitance	f =1.0MHz		30		1
Rg	Gate Resistance	V _{GS} =V _{DS} =0V, f =1.0MHz		1.5		Ω
	-			-		-



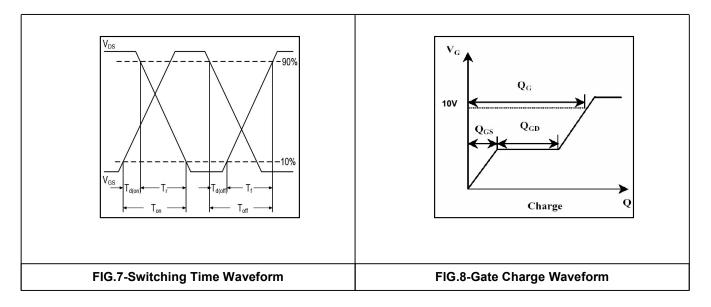
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• Typical Electrical Characteristics





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